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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

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FDS86141 N-Channel Power Trench[®] MOSFET 100 V, 7 A, 23 m Ω

Features

- Max $r_{DS(on)} = 23 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 7 \text{ A}$
- Max $r_{DS(on)}$ = 36 m Ω at V_{GS} = 6 V, I_D = 5.5 A
- High performance trench technology for extremely low r_{DS(on)}
- 100% UIL Tested
- RoHS Compliant

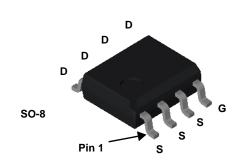


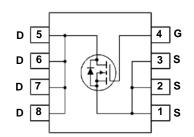
General Description

This N-Channel MOSFET is produced using ON Semiconductor's advanced Power Trench[®] process that has been especially tailored to minimize the on-state resistance and yet maintaiin superior switching performance.

Applications

DC-DC Conversion





MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			100	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous			7	•	
I _D	-Pulsed			30	— A	
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	121	mJ	
P _D	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5		
	Power Dissipation	T _A = 25 °C	(Note 1b)	1.0		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

 $R_{\theta JA}$

N N	Thermal Resistance. Junction to Ambient	(Note 1a)	50	°C/W	I
4		(00	••••	L

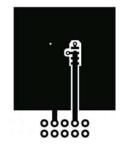
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDS86141	FDS86141	SO-8	13 "	12 mm	2500 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
	acteristics			.76		••••••	
		l		1	1	1	
BV _{DSS}	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu A, \ V_{GS} = 0 \ V$	100			V	
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, referenced to 25 °C		67		mV/°C	
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 80 V, V_{GS} = 0 V$			1	μΑ	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA	
On Chara	octeristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2	3.1	4	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_{I}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		-10		mV/°C	
0		V _{GS} = 10 V, I _D = 7 A		19	23		
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 6 \text{ V}, \text{ I}_{D} = 5.5 \text{ A}$		27	37	mΩ	
20(01)		V _{GS} = 10 V, I _D = 7 A, T _J = 125 °C		33	40	-	
9 _{FS}	Forward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 7 \text{ A}$		19		S	
C _{iss} C _{oss} C _{rss} R _q	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1 MHz		703 186 8.6 0.5	934 247 13	pF pF pF	
0	g Characteristics			0.0			
t _{d(on)}	Turn-On Delay Time			8.3	17	ns	
t _r	Rise Time	V _{DD} = 50 V, I _D = 7 A,		3.2	10	ns	
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		14.3	26	ns	
t _f	Fall Time			3.2	10	ns	
	Total Gate Charge	$V_{GS} = 0 V$ to 10 V		11.8	16.5	nC	
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V V_{DD} = 50 V$		6.7	9.4	nC	
Q _{gs}	Total Gate Charge	$I_D = 7 \text{ A}$		3.4		nC	
Q _{gd}	Gate to Drain "Miller" Charge			3.1		nC	
*	urce Diode Characteristics	· · · · · ·					
		$V_{GS} = 0 V, I_S = 7 A$ (Note 2)		0.8	1.3		
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.8	1.2	V	
		<u> </u>					
t _{rr}	Reverse Recovery Time	— I _F = 7 A, di/dt = 100 A/μs		43	69	ns	

NOTES:

1. R_{0JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



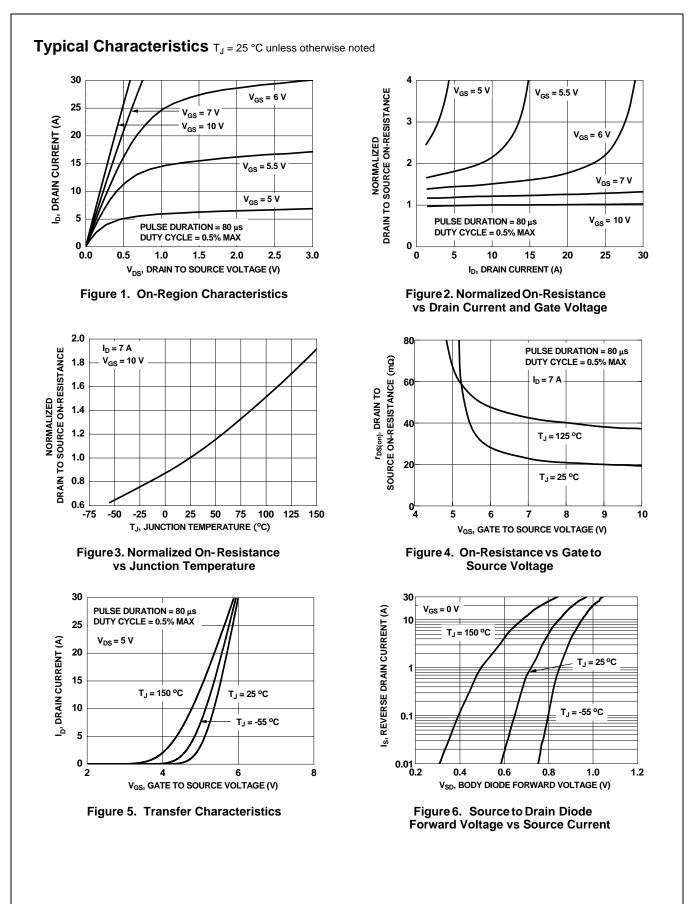
a) 50 °C/W when mounted on a 1 in² pad of 2 oz copper.



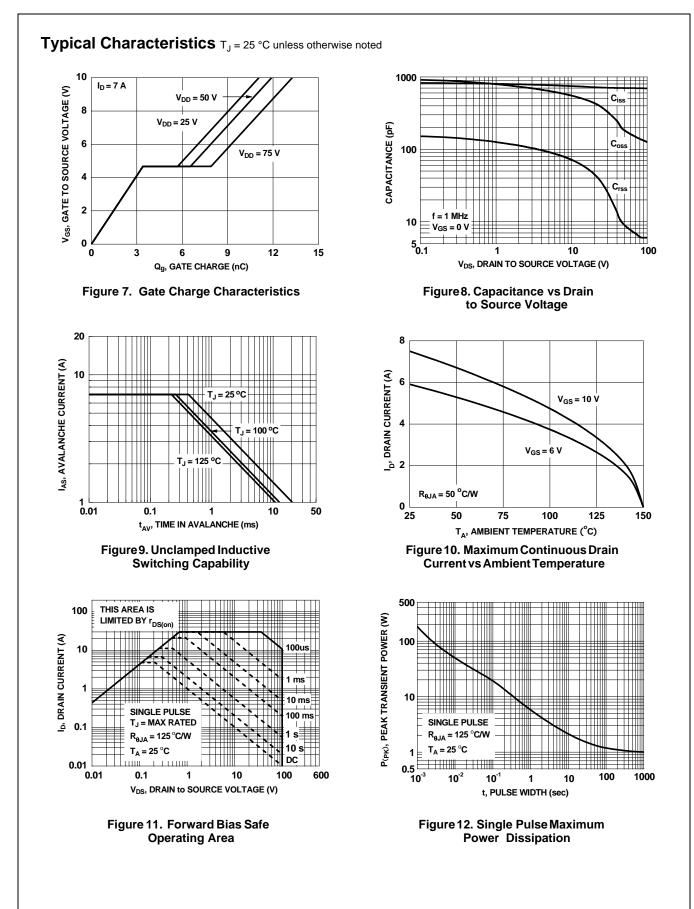
b) 125 °C/W when mounted on a minimum pad.

2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0 %.

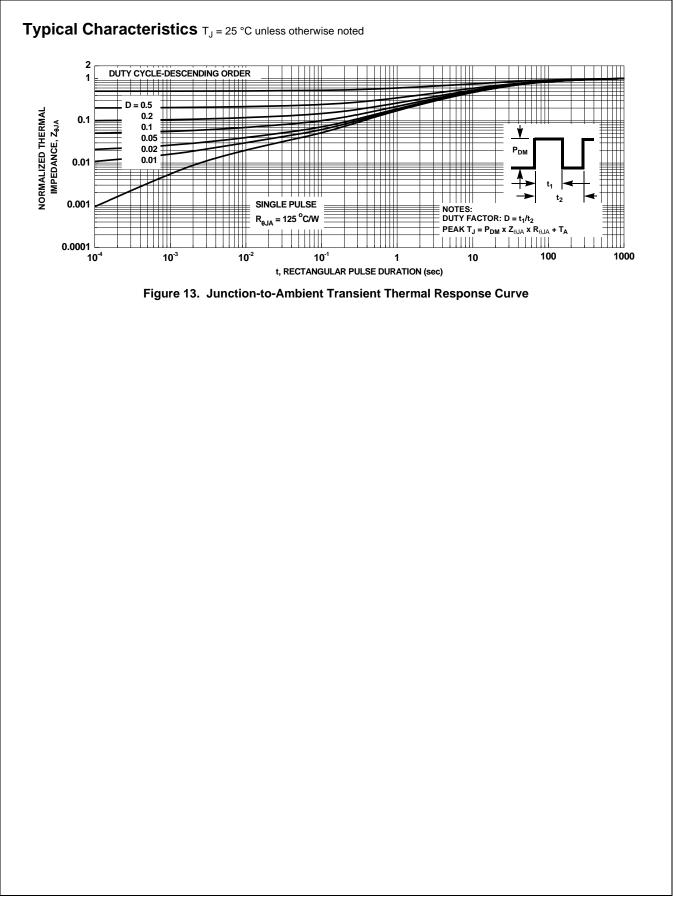
3. Starting T_J = 25 $^oC;$ N-ch: L = 3 mH, I_{AS} = 9 A, V_{DD} = 100 V, V_{GS} = 10 V.







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FDS86141 N-Channel Power Trench[®] MOSFET



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